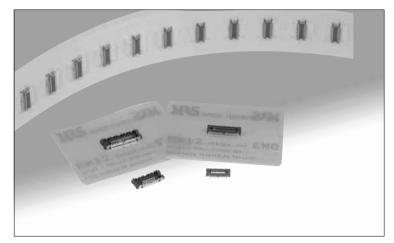
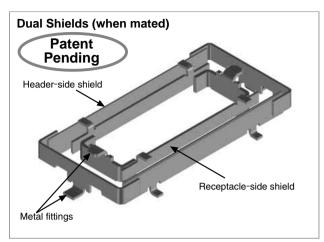
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0.4 mm Pitch, 1.5 mm Board-to-Board Connectors with Dual Shields

FX12 Series





Features

1. Dual shields

Built-in shield plates and metal fittings in the plugs and receptacles prevent electromagnetic emission and external interference on the entire 360° periphery of mated connectors.

2. Low-Profile

Board-to-Board distance of 1.5 mm and reduced PCB mounting pattern allows use in applications where space is limited.

3. Self alignment

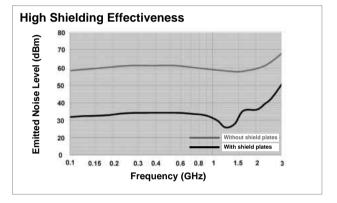
Built-in self-alignment feature in the plug and receptacle allows mating / un-mating in limited spaces.

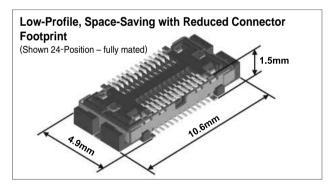
4. Consistent mated retention force

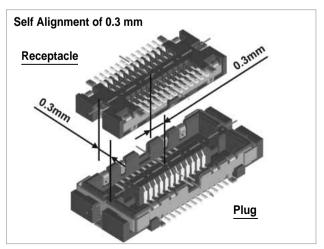
Indents in the shield plates and contact configuration assure consistency of the mated retention forces irrespective of the contact numbers. Positive "click" sensation confirms fully mated condition.

- 5. Solder wicking prevention Nickel plating barrier on the contacts prevents solder compound intrusion (wicking) into the contact engagement areas.
- 6. Board placement with automatic equipment Packaged on tape-and-reel, the connectors have flat areas (0.8mm) to allow use of vacuum nozzles.
- 7. RoHS Compliant

All components and materials comply with the requirements of the EU Directive 2002/95/EC.







HS _{A263}

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Specifications								
Rating	Current rating 0.3A Voltage rating 30V AC	Operating temperature range -55℃ to +85℃ (Note 1)	Storage temperature range -10°C to +60°C (Note 2) Storage humidity range Relative humidity 95% max. (No condensation)					

Item	Specification	Conditions
1.Insulation resistance	50 MΩ min.	100V DC
2.Withstanding voltage	No flashover or insulation breakdown.	100V AC/one minute
3.Contact resistance	100 mΩ max.	100 mA
4.Vibration	No electrical discontinuity of 1μ s or more.	Frequency: 10 to 55 Hz, single amplitude of
	No damage, cracks or parts dislocation.	0.75mm, 3 axis, 10 cycles
5.Shock	No electrical discontinuity of 1μ s or more.	Acceleration of 490 m/s ² , 11 ms duration, sine half-
	No damage, cracks or parts dislocation.	wave waveform, 3 cycles / each of 3 axis
6.Humidity	Contact resistance: 120 mΩ max.	
	Insulation resistance: 25 MΩ min.	96 hours at 40℃, 90% to 95% R.H.
	No damage, cracks or parts dislocation.	
7.Temperature cycle	Contact resistance: 120 mΩ max.	Temperature: -55° C $\rightarrow +15^{\circ}$ C to 35° C $\rightarrow +85^{\circ}$ C $\rightarrow +15^{\circ}$ C to $+35^{\circ}$ C
	Insulation resistance: 50 MΩ min.	Time: $30 \rightarrow 2$ to $3 \rightarrow 30 \rightarrow 2$ to 3 (Minutes)
	No damage, cracks or parts dislocation.	5 cycles
8.Durability	Contact resistance: 120 mΩ max.	30 cycles
(mating / un-mating)	No damage, cracks or parts dislocation.	SU CYCLES
9.Resistance to	No deformation of components affecting performance.	Reflow: At the recommended temperature profile
soldering heat	no detormation of components affecting performance.	Manual soldering: 360℃ for 5 seconds

Note 1: Includes temperature rise caused by current flow.

Note 2: The term "storage" refers to products stored for long period of time prior to mounting and use. Operating temperature range and humidity range covers non-conducting condition of installed connectors in storage, shipment or during transportation.

Note 3: Information contained in this catalog represents general requirements for this Series. Contact us for the drawings and specifications for a specific part number shown.

Materials

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Part	Material		Finish	Remarks	
Insulator	Polyamide		Color: Black	UL94V-0	
Contacts	Phosphor bronze	Plug Receptacle Selective gold plated			
Ground plates			Gold plated		
Metal fittings			Tin plated		

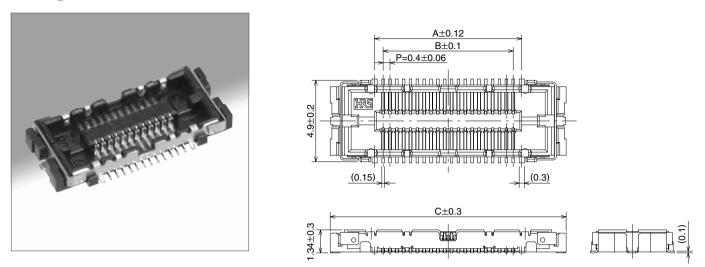
Ordering information

$\frac{FX12}{0} \quad \frac{B}{2} - \frac{24}{6} \frac{P}{0} - \frac{0.4}{6} \frac{SV}{6}$

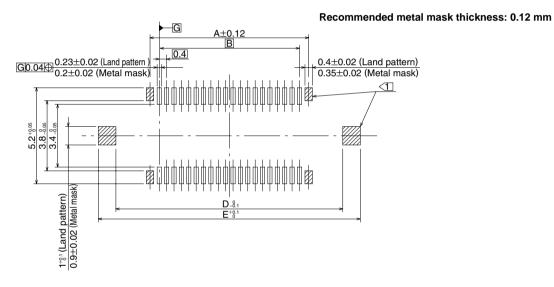
Series name: FX12	Onnector type
② Configuration	P: Plug
B: Without guide post	S: Receptacle
Number of positions: 24, 40, 60	G Contact pitch: 0.4 mm
	 Termination configuration
	SV: SMT

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Plugs



Recommended PCB Mounting Pattern and Metal Mask Dimensions



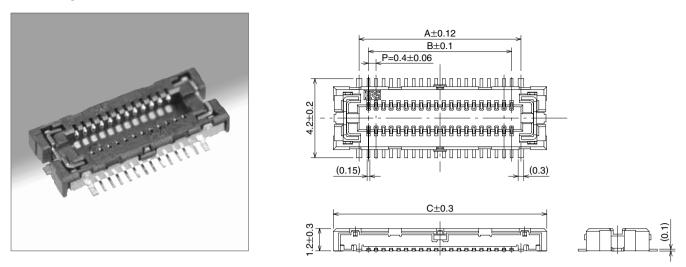
Notes:

- $\fbox{1} Positions marked \textcircled{2} indicate a ground circuit connections.}$
- 2 The co-planarity of SMT terminations is 0.1 maximum.
- 3 No polarity orientation for board mounting.
- 4 Dimensions in parentheses () are reference dimensions.
- 5 All dimensions in mm.

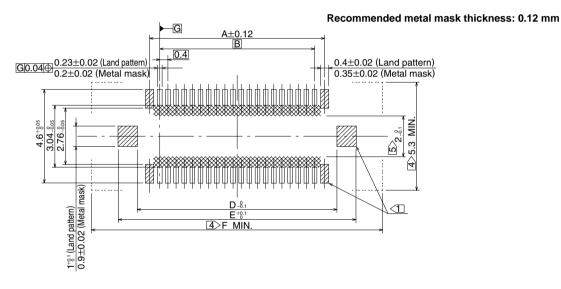
Part number	CL No.	Number of positions	А	В	С	D	E	RoHS
FX12B-24P-0.4SV	573-1005-0	24	5.4	4.4	10.6	9.1	11.0	
FX12B-40P-0.4SV	573-1001-0	40	8.6	7.6	13.8	12.3	14.2	YES
FX12B-60P-0.4SV	573-1007-6	60	12.6	11.6	17.79	16.3	18.2	

Packaging : 3,000 pieces per reel

Receptacles



Recommended PCB Mounting Pattern and Metal Mask Dimensions



Notes:

- 1 Positions marked *market* indicate a ground circuit connections.
- 2 The co-planarity of SMT terminations is 0.1 maximum.
- 3 No polarity orientation for board mounting.
- \blacksquare Do NOT place any components within area indicated by the broken line \square .
- **5** Do NOT place conductive traces in areas indicated by \bigotimes .
- 6 Dimensions in parentheses () are reference dimensions.
- 7 All dimensions in mm.

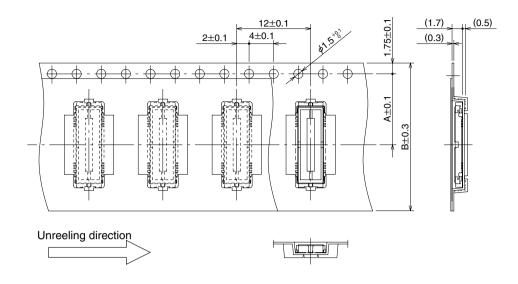
Part number	CL No.	Number of positions	А	В	С	D	E	F	RoHS
FX12B-24S-0.4SV	573-1006-3	24	5.4	4.4	8.14	6.6	8.5	11.1	
FX12B-40S-0.4SV	573-1002-2	40	8.6	7.6	11.34	9.8	11.7	14.3	YES
FX12B-60S-0.4SV	573-1008-9	60	12.6	11.6	15.34	13.8	15.7	18.3	

Packaging : 3,000 pieces per reel

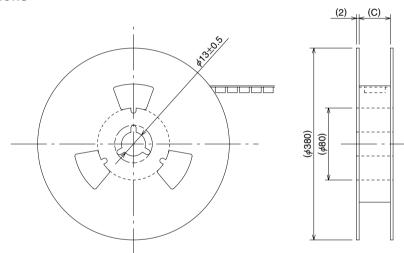
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■Packaging Specifications





Reel dimensions



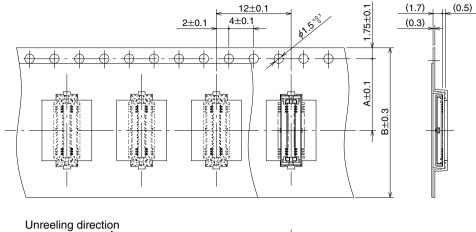
Part number	А	В	С
FX12B-24P-0.4SV	11.5	24.0	24.4
FX12B-40P-0.4SV	11.5	24.0	24.4
FX12B-60P-0.4SV	14.2	32.0	32.4

All dimensions in mm

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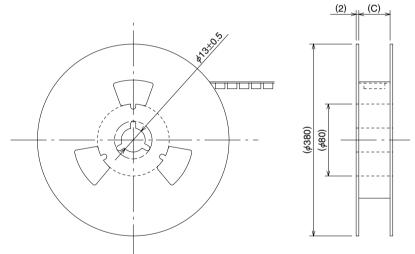
■Packaging Specifications

Receptacle





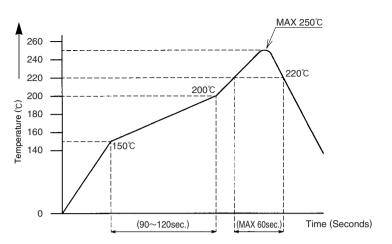
Reel dimensions



Part number	A	В	С
FX12B-24S-0.4SV	11.5	24.0	24.4
FX12B-40S-0.4SV	11.5	24.0	24.4
FX12B-60S-0.4SV	11.5	24.0	24.4

All dimensions in mm

Recommended solder temperature profile.



Note: The temperature profile indicates the maximum temperature of the connector surfaces at the highest point from the PCB mounting surface.

< HRS test conditions >				
Solder method	:Reflow			
Environment	:Room air			
Solder paste	:96.5%Sn/3.0%Ag/0.5%Cu			
Test board	:Glass epoxy 40mm \times 30mm \times 1mm			
	thick			
Metal mask	:0.12mm thick			
Reflow cycles	:2cycles			

The temperature profiles shown are based on the above conditions.

In individual applications the actual temperature may very, depending on solder paste type, volume / thickness and board size/ thickness. Cosult your solder paste and equipment manufacture for specific recommendations.

Cleaning recommendations

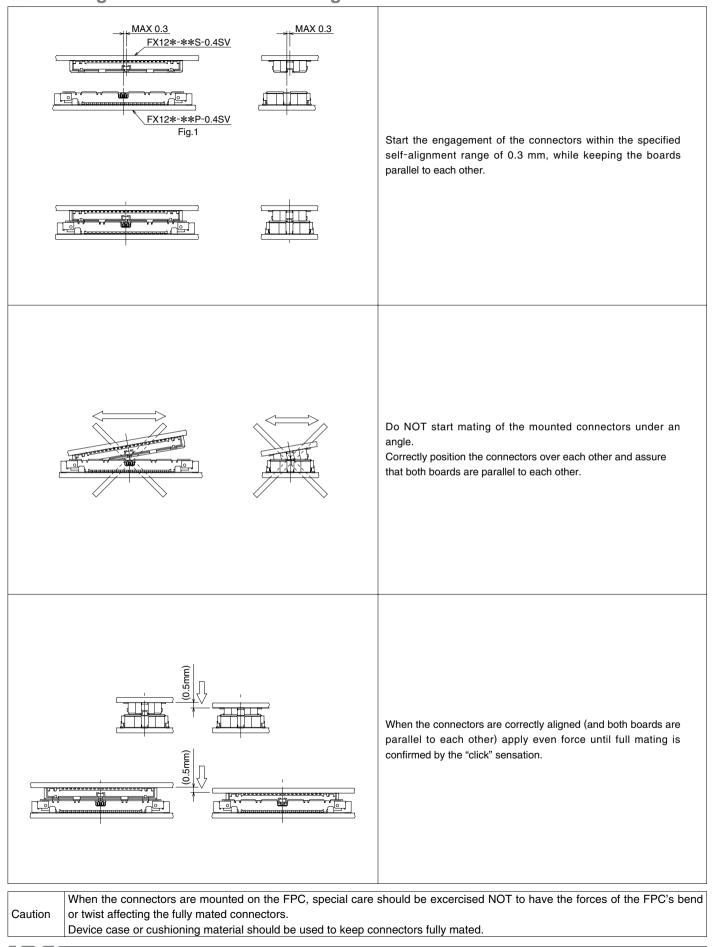
Organic solvent cleaning

Solvent type	Room temperature cleaning	Heated cleaning
IPA (Isoporopyl alcohol)	YES	YES
HCFC (Hydrochlorofluorocarbon)	YES	YES

Water based cleaning

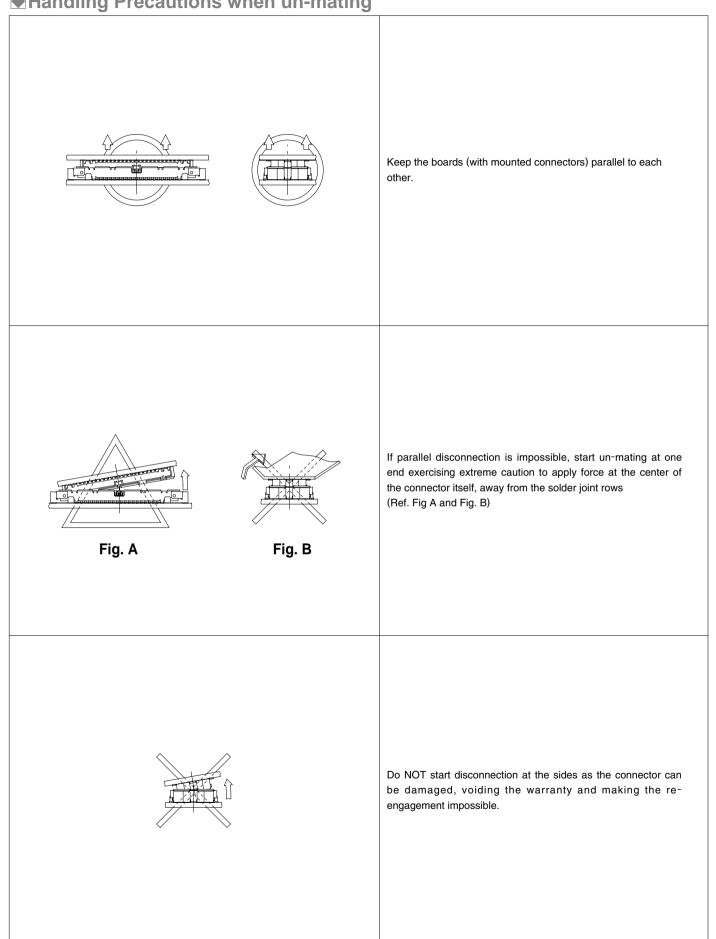
When using water based cleaning agents (e.g., terpene, alkali saponifiers), select the cleaning agent based on the documentation issued by the various manufacturers of cleaning agents which describes it's affects on metals, platings and plastics. Remove any moisture after cleaning. Residual flux or cleaning agents in the contact areas may affect electrical performance.

Handling Precautions when mating mounted connectors.



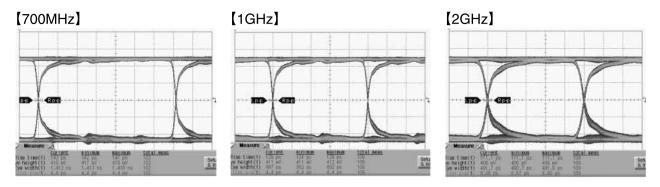
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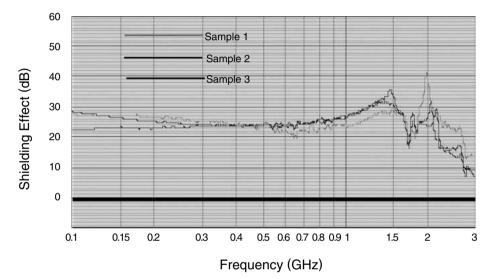


Technical Documentation

• Eye Pattern Output Waveform



• Shielding Characteristics (1) (Measurement Results Using a 2-Chamber Shielded Room)

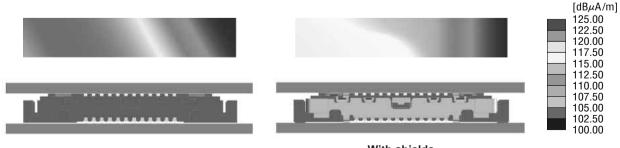


Explanatory Note

Measurement values of the unshielded connectors were set as the zero level of the vertical axis of the graph. The graph uses unshielded connectors as the reference and indicates the noise leakage suppression (shielding) effect of the shielded connectors as a relative comparison value.

In comparison to the unshielded connectors there was a noise suppression effect of 10 dB to 30 dB over the frequency range of 100 MHz to 3 GHz.

Shielding Characteristics (2) (Board-to-Board Shielding Comparison Using a Magnetic Field Probe Method: IEC 61967-6 Compliance)



Without shields

With shields

Explanatory Note

A signal of the 266 MHz operating frequency was transmitted through all contacts, over a frequency range of 10 MHz to 3 GHz. The magnetic field leaking to the surroundings from the gap between the boards was measured with a magnetic probe to provide the (mapping data) results.